

PRIMERGY RX2520 M1

System configurator and order-information guide

April 2017

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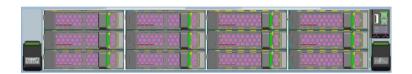
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PRIMERGY Server

Instructions

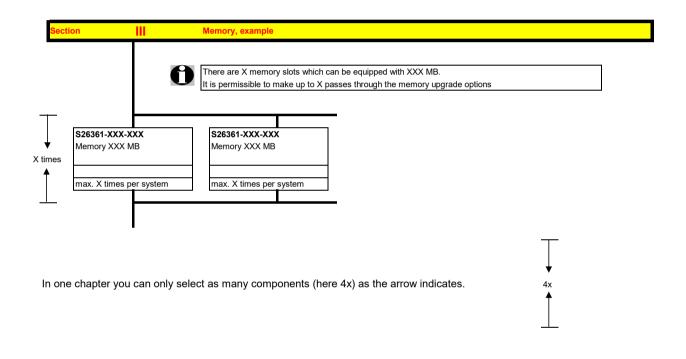
This document contains basic product and configuration information that will enable you to configure your system via PC-/System-Architect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



For further information see:

http://ts.fujitsu.com/products/standard_servers/inc (internet)

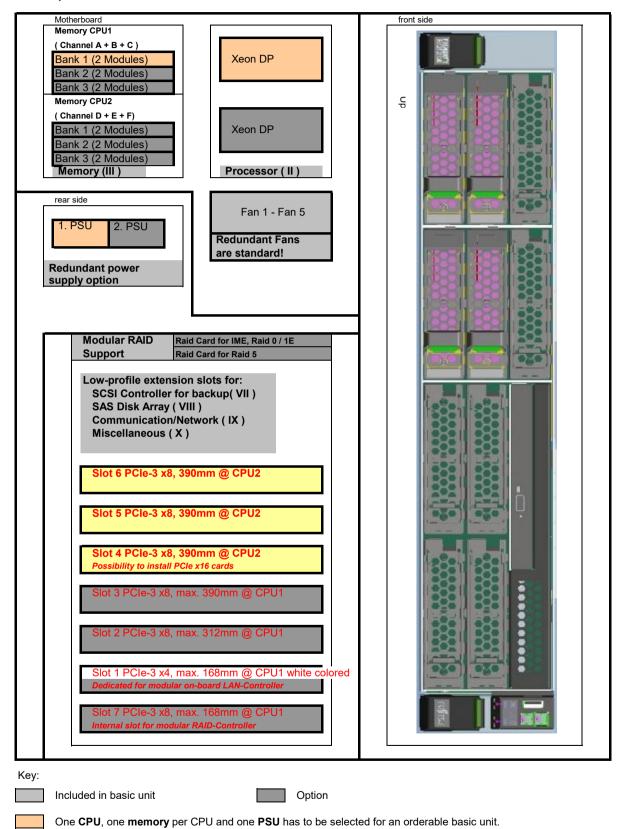
Please note that there are information symbols which indicate necessary information.

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy config/current/Pages/default.aspx (extranet)

Configuration diagram PRIMERGY RX2520 M1

System unit (I)

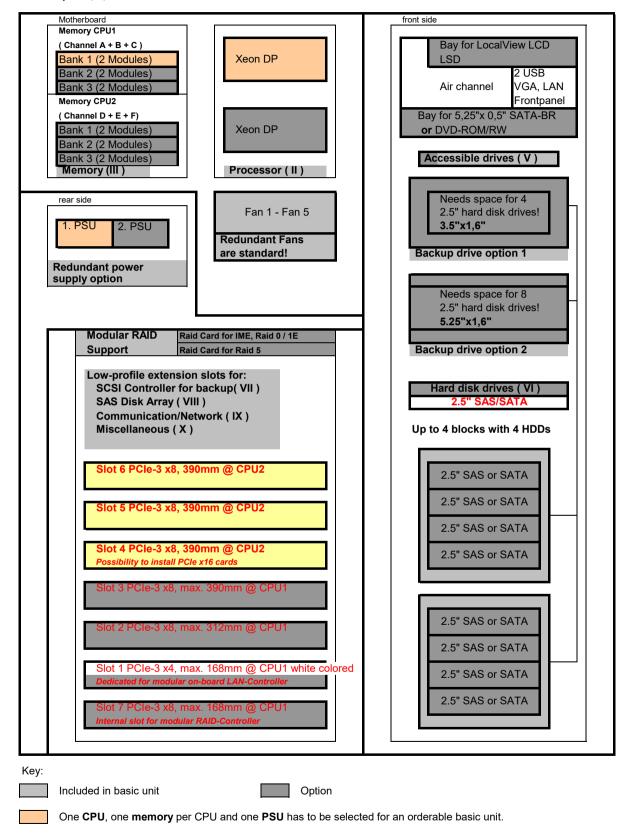
with up to 8x or 12x 3.5" Hard disk drives



Configuration diagram PRIMERGY RX2520 M1

System unit (I)

with up to 4, 8, 12 or 16x 2.5" Hard disk drives



Section

Basic unit



System unit consisting of:

- * 2U Housing without power supply modules
- Basic units with:
- 2 Hot-Plug Power Supply Bays
- 4 Bays for fans: 2 + 1 fans (redundancy option), 2nd CPU requires additional fan!

note: 12x 3.5" HD basic unit contains allways 5 fans!

- 6 memory DIMMs per CPU => Total 12 DIMMs for two CPU's
- SAS Backplane for 12x 3.5" HD, SAS Backplanes for 4, 8, 12 or 16x 2.5" HD or PCle Backplanes for with cable connection to on-board, modular RAID Controller

* Drives/Bays

- 8 or 12 bays 1" for hot plug 3.5" HD (1" high) or 4, 8, 12 or 16 bays for hot plug 2.5" HD
- 1 bay for 3.5" and 1.6" high Backup device, not possible for 3.5" HD basic units
- or for basic unit with 12 or 16 x 2,5" HD
- 1 bay for 5.25" and 1.6" high Backup device, not possible for basic units 3.5" HD or for basic unit with 12 or 16 x 2.5" HD
- 1 bay SATA-CD- or DVD-ROM 0,5" height (option), not possible for 12x 3.5" HD basic unit
- 1 bay for opt. LocalView LC-Display, not possible for 3.5" HD basic units
- * Integrated ServerView Diagnostics Technology (Diagnosis LED's) for indication of internal failed components

Systemboard D3169 with:

* Up to two Xeon DP CPU's (Socket-B2)

with 1 serial QPI link (Quick Path Interconnect) and three memory channels per CPU

First CPU has to be selected for an orderable basic unit,

* Chipset Intel® C600 Series (codenamed Patsburg)

* 7 PCI slots: - 3x PCIe-3 x8 (Slots are connected to CPU 2, useable with configured 2nd CPU only!)

all Gen 3

- 2x PCle-3 x8 - 1x PCle-3 x4 Gen 2 only
- 1x PCle-3 x8 (for internal modular RAID controller only)
- * 12 memory slots for max. 192 GB RAM DDR3 available
- Memory is divided into 6 DIMMs per CPU (3 channels with 2 slots per channel)

Possible max. configurations are:

12x 16GB RDIMM (dual rank modules) = 192 GB

12x 32GB LRDIMM (quad rank modules) = 384 GB on project release only 12x 64GB LRDIMM (quad rank modules) = 768GB on project release only

First Memory (one module) has to be selected for an orderable basic unit per CPU

- Memory upgrade is possible module wise

Dual Port 10/100/1000 x4 PCI Express* Gigabit Ethernet Intel LAN controller Powerville on-board

* iRMC S4 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100/1000 Service LAN-port and integrated graphics controller.

The Service LAN-port can be switched alternatively on standard Gbit LAN port 1

Graphics Controller integrated in iRMC S4 (integrated Remote Management Controller): 1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz

(1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)

Interfaces at the rear:

- * 1x RS-232-C (serial, 9 pins) (usable for BMC or OS or shared)
- * 1x VGA (15 pins)
- * 4x USB **2.0** (UHCI) with **480MBit/s**, no USB wakeup
- * 2x LAN RJ45, 1x Service-LAN RJ45

Interfaces on the front:

- * 2x USB **2.0** (UHCI) with **480MBit/s**, no USB wakeup
- * 1x VGA (15 pins) as an option
- * 1x Service-LAN RJ45 as an option

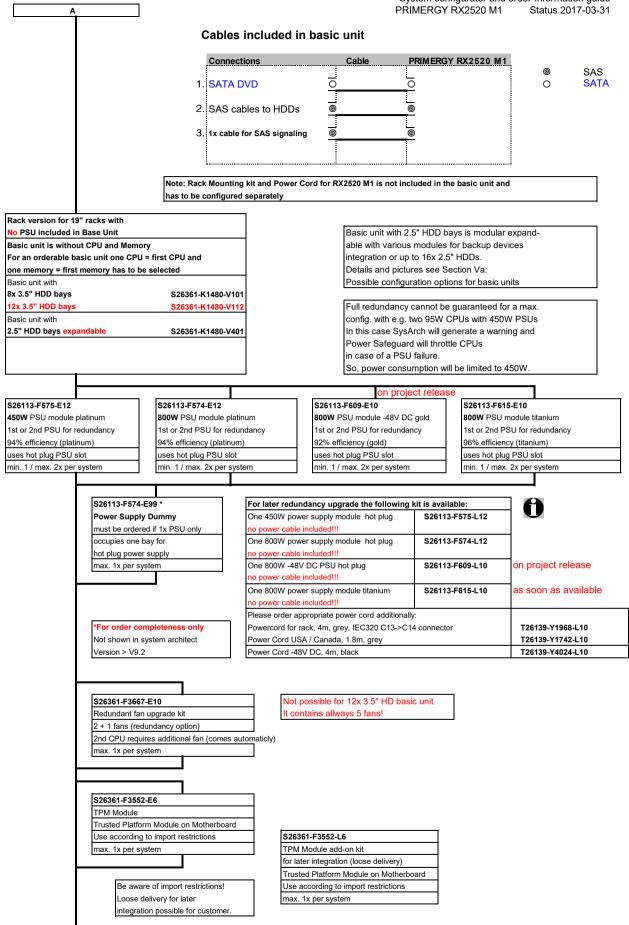
Interfaces internal:

- * 1x released internal USB Interfaces for backup devices,
- * 1x USB 2.0 (UHCI) with 480MBit/s for dongle funcionality (uSSD memory), no USB wakeup
- 1x SATA interface for DVD (only usable with 4x 2.5" HDD + DVD Option)
- * 4x SATA/SAS interface for 4 SATA/SAS HD`s or SAS Backup device
- * 2x USB 2.0 ports for internal USB redirection connected to BMC

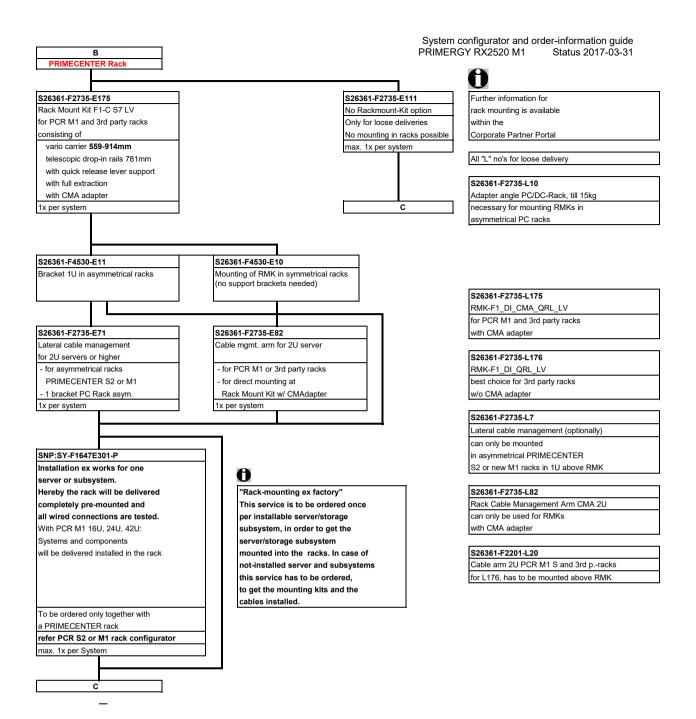
Software:

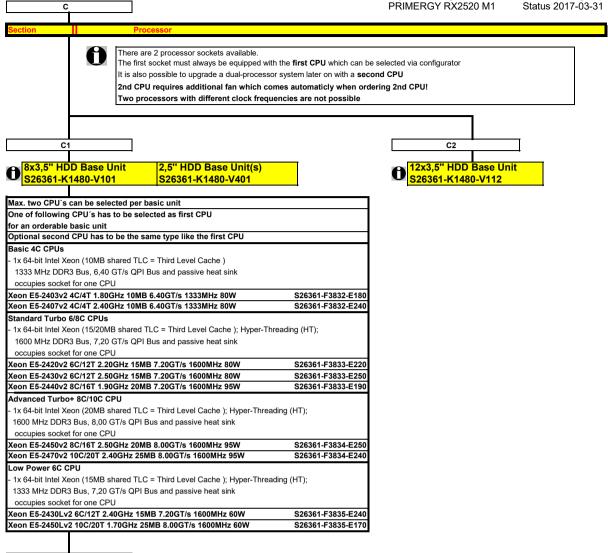
- ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates
- * Documentation engl. (multilingual on CD)

Α

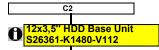


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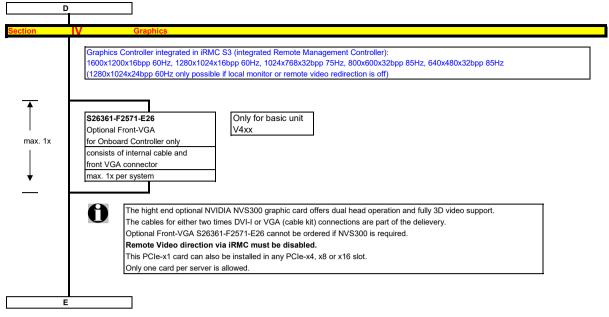


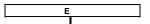


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as soon as avai Max. two CPU's can be selected per basic unit		
One of following CPU's has to be selected as first CPU		
for an orderable basic unit		
Optional second CPU has to be the same type like the first CPU		
Basic 4C CPUs		
- 1x 64-bit Intel Xeon (10MB shared TLC = Third Level Cache)		
1333 MHz DDR3 Bus, 6,40 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2403v2 4C/4T 1.80GHz 10MB 6.40GT/s 1333MHz 80W	S26361-F3832-E1	
Xeon E5-2407v2 4C/4T 2.40GHz 10MB 6.40GT/s 1333MHz 80W	S26361-F3832-E2	
Standard Turbo 6/8C CPUs		
- 1x 64-bit Intel Xeon (15/20MB shared TLC = Third Level Cache); Hyper-Tl	nreading (HT);	
1600 MHz DDR3 Bus, 7,20 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2420v2 6C/12T 2.20GHz 15MB 7.20GT/s 1600MHz 80W	S26361-F3833-E2	
Xeon E5-2430v2 6C/12T 2.50GHz 15MB 7.20GT/s 1600MHz 80W	S26361-F3833-E2	
Xeon E5-2440v2 8C/16T 1.90GHz 20MB 7.20GT/s 1600MHz 95W	S26361-F3833-E1	
Advanced Turbo+ 8C/10C CPU		
- 1x 64-bit Intel Xeon (20MB shared TLC = Third Level Cache); Hyper-Three	ading (HT);	
1600 MHz DDR3 Bus, 8,00 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2450v2 8C/16T 2.50GHz 20MB 8.00GT/s 1600MHz 95W	S26361-F3834-E2	
Xeon E5-2470v2 10C/20T 2.40GHz 25MB 8.00GT/s 1600MHz 95W	S26361-F3834-E2	
Low Power 6C CPU		
- 1x 64-bit Intel Xeon (15MB shared TLC = Third Level Cache); Hyper-Three	ading (HT);	
1333 MHz DDR3 Bus, 7,20 GT/s QPI Bus and passive heat sink		
occupies socket for one CPU		
Xeon E5-2430Lv2 6C/12T 2.40GHz 15MB 7.20GT/s 1600MHz 60W	S26361-F3835-E2	
Xeon E5-2450Lv2 10C/20T 1.70GHz 25MB 8.00GT/s 1600MHz 60W	S26361-F3835-E1	
D	320301-1-3035	







- There are 6 memory slots per CPU for max.

96GB RDIMM (6x 16GB 2R)

currently up to 192GB for two CPUs (96GB per CPU), using RDIMM

- The memory area is divided into 3 channels per CPU with 2 slots per channel - Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2

Memory can be operated at 1.5V or 1.35V, even if the modules are of low voltage type.

Memory operating voltage can be set within BIOS (1.5V is default setting for max. speed).

In a 2 DIMMs per channel configuration the max memory speed is 1600 MHz (depending on CPU) @1.35V the max memory speed is 1333MHz max

SDDC (Chipkill) is supported for registered x4 organized memory modules only

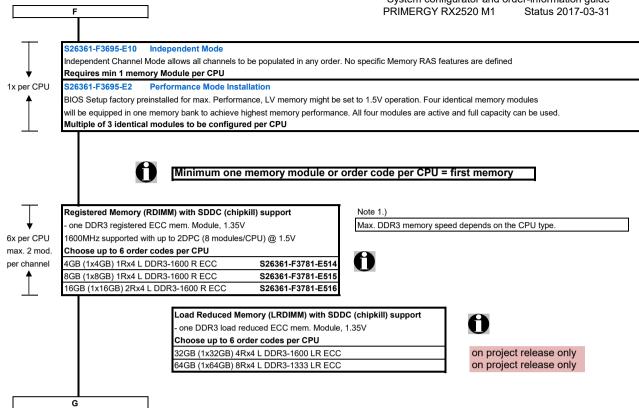
1.) In the "Independent Channel Mode" is following configuration possible Channels can be populated in any order in Independent Channel Mode. All four channels may be populated in any order and have no matching requirements. All channels must run at the same interface frequency but individual channels may run at

different DIMM timings (RAS latency, CAS latency, and so forth) 2.) "Performance Mode" configuration

- In this configuration, the memory module population ex factory is spread across all channels.

The BIOS is set to the max. performance for memory.

Minimum configuration is: 3x identical modules



Memory Configuration PRIMERGY RX2520 M1

Each CPU offers 6 Slots for DDR3 Memory Modules organised in 2 Banks and 3 Channels.

If you need more than 6 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 2 basic modes of operation (see explanation below).

Mode	Configuration	RDIMM	Application
		x4	
SDDC (chipkill) support	any	yes	detect multi-bit errors
Independant Channel Mode	1, 2 or 3 Modules per Bank	yes	offers max. flexibility, upgradeability, capacity use UDIMM modules for lowest cost
Performance Mode	3 identical Modules / Bank	yes	offers maximum performance and capacity

^{*)} For the delivery ex works the system will be prepared with dedicated BIOS setting.

Capacity	Configuration	RDIMM	Notes
Min. Memory per CPU	1 Module / CPU	4GB	with one CPU
Max. Memory per CPU	6 Modules / CPU	96GB	with one CPU
Max. Memory per System	12 Modules / System	192GB	if second CPU is configured

Memory-Speed:

Max. DDR3 memory speed depends on the speed of the CPU

Real maximum memory-bus speed depending on CPU type and voltage setting (BIOS; default is 1.5V)

Mem. Speed provided by CPU	RDI	MM 1	600N	1Hz
Voltage setting (BIOS)	1.5V 1.35V		55V	
DIMM per Channel (DPC)	1	2	1	2
CPU with 1600MHz DDR3 Bus	1600	1600	1333	1333
CPU with 1333MHz DDR3 Bus	1333	1333	1333	1333

Configuration hints:

- The memory sockets on the systemboard offer a color coding:

Bank I black sockets
Bank II blue sockets

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below) **Bank I on CPU 1/2** up to 3 memory modules connected to Channel A - F on the 1st/2nd CPU

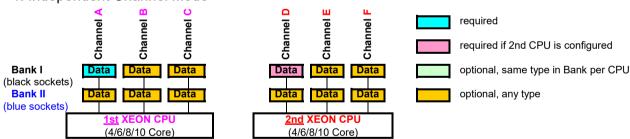
Bank I on CPU 1/2 up to 3 memory modules connected to Channel A - F on the 1st/2nd CPU

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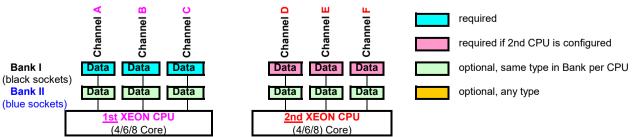
- See below and next page for a detailed descriptions of the memory configuration supported.

1. Independent Channel Mode

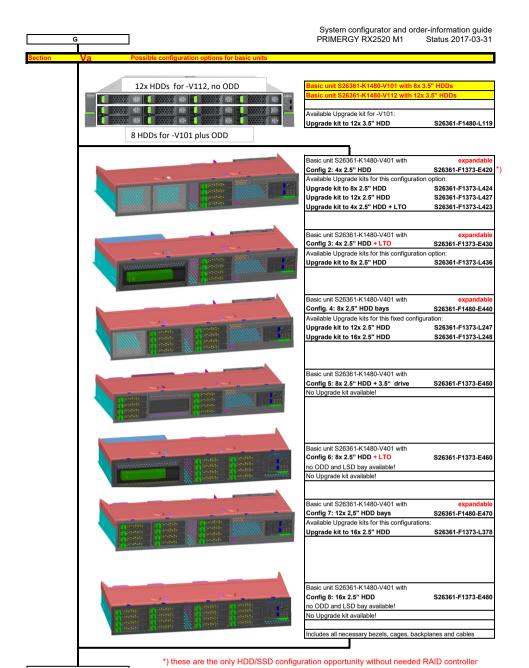


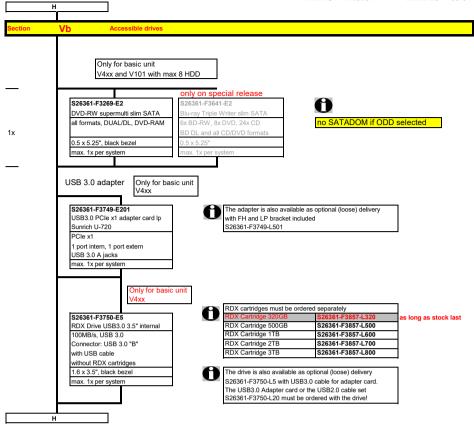
Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system

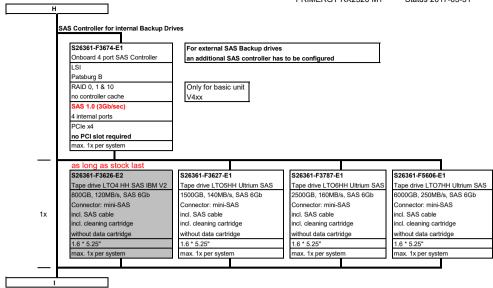
2. Performance Channel Mode

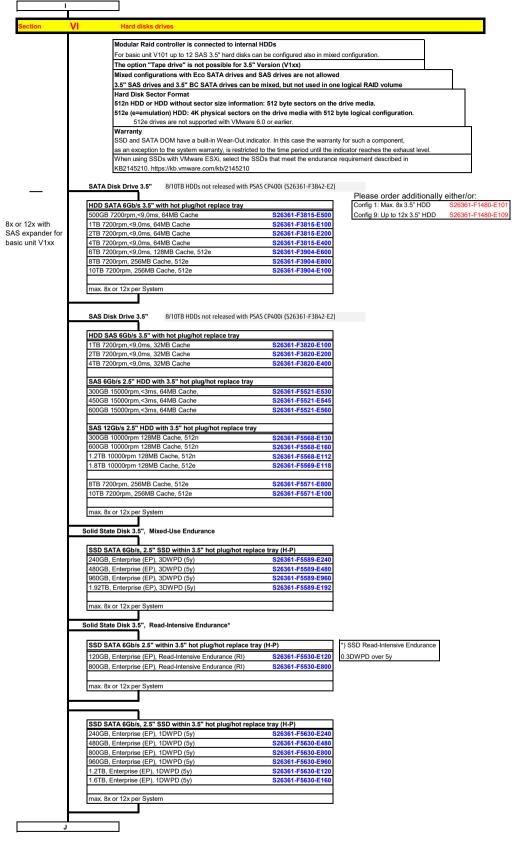


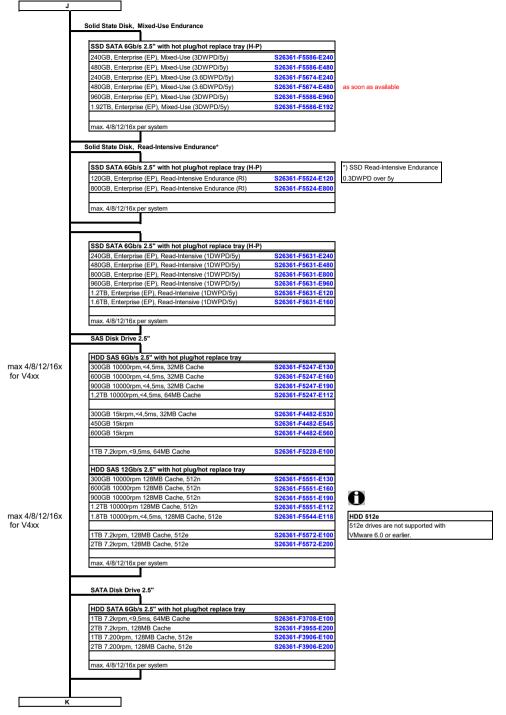
Performance Channel Mode requires identical modules on all channels of each Bank per CPU. If this mode is used, a multiple of 3 identical modules has to be ordered.

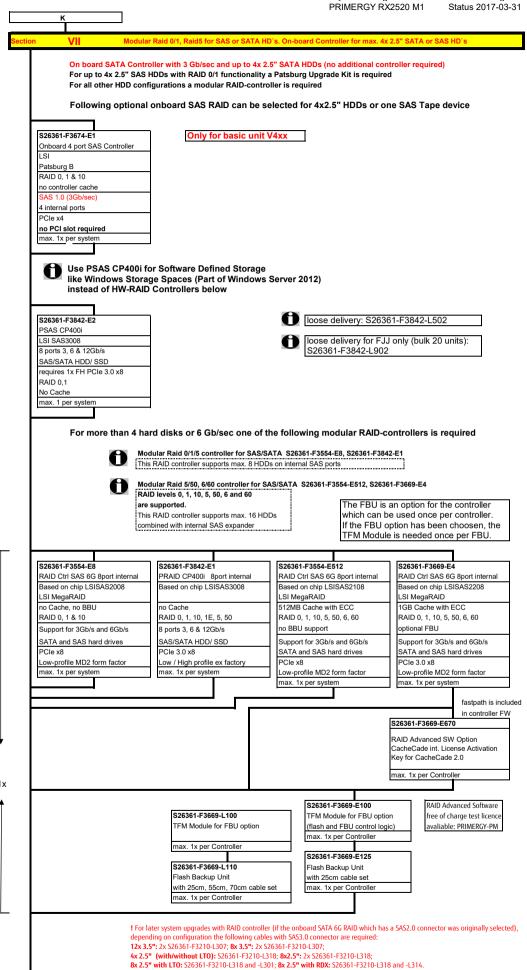


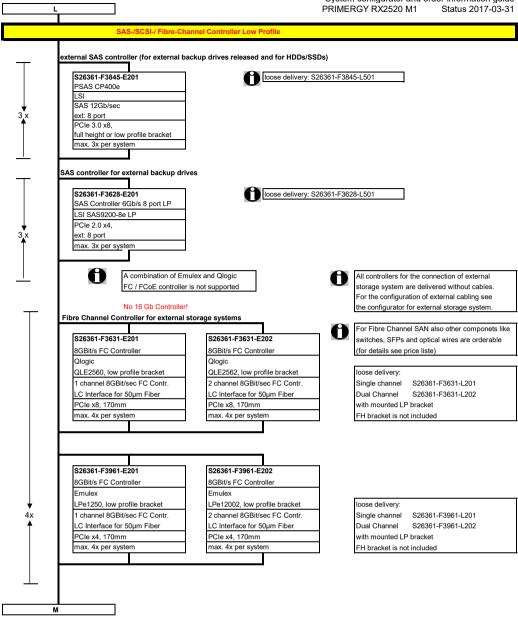


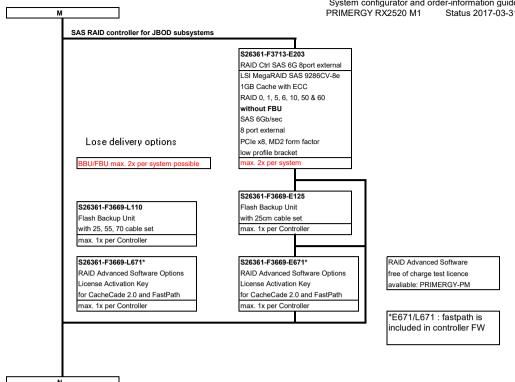


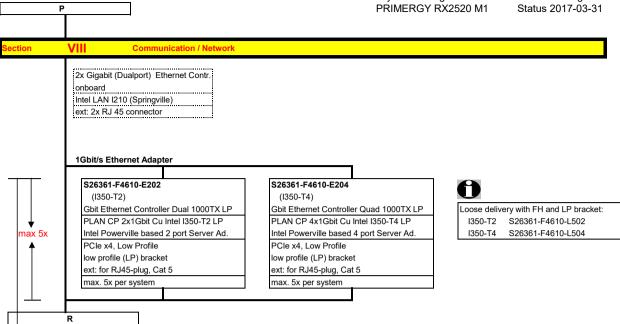




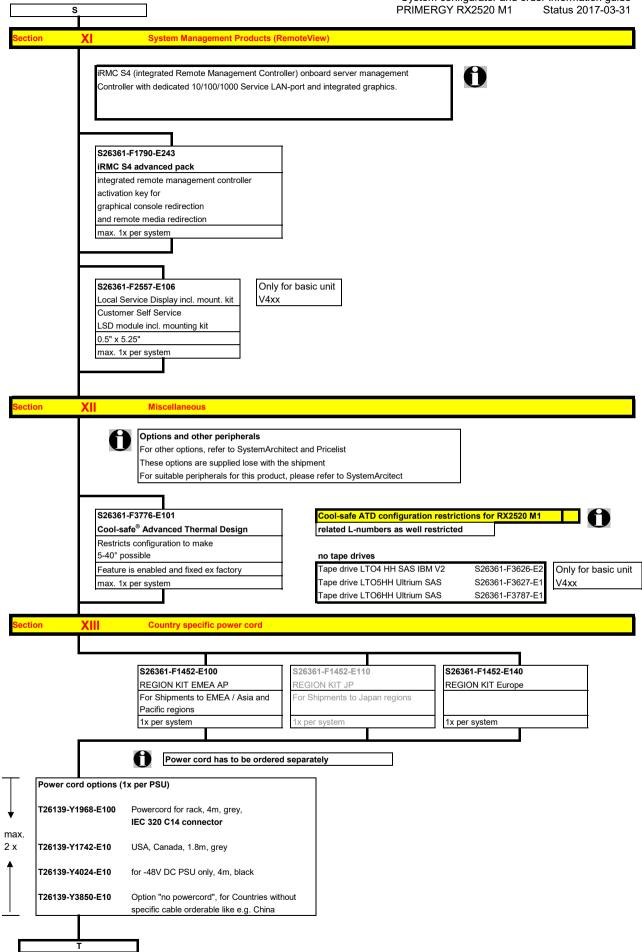


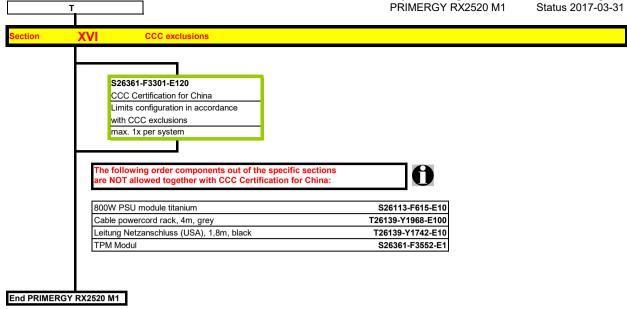






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Change Report

Date	Order number	Changes
2017-10-19	\$26361-F5289/F5303-*	removed (EOL)
2017-09-05 2017-07-24	S26361-F3819-E530 S26361-F5674-*	removed (EOL) added
2017-07-24	RAID controller section	Added information about SAS3.0 cables for later upgrades to include RAID controller
2017-06-06	F5586/F5589-E120 / F5524/F5530-E2	
2017-03-22	HD SSD	updated
2017-02-01	S26361-F3626-E2	added comment(to pre-removed) LTO4 drive.
2017-02-01	S26361-F3857-L800	added 3TB capacity, removed 320GB capacity.
2017-01-17	8/10TB HDDs	Info-Text added
2017-01-06	S26361-F5524/F5586/F5530/F5589-*	added
2016-12-21	S26361-F5630/F5631-*	added
2016-12-21	S26361-F3819-E545/E560	removed
2016-12-21	\$26361-F4482-E514	removed
2016-12-21 2016-09-27	S26361-F3904/F5571-E800/E100 S26361-F2735-L10	added
2016-09-27	S26361-F2735-L10 S26361-F2748-E637/L637	corrected from 50kg to 15kg removed
2016-09-15	S26361-F5606-E1/L1	LTO7 drive added
2016-08-05	S26361-F3955-E200	added
2016-05-12	S26361-F3641-E2	Blu-ray Triple Writer slim only on special release
2016-05-10	S26361-F3669-E660/L660	removed
2016-03-21	S26361-F1452-E140	added region kit Europe
2016-03-14	T26139-Y1742-E10	changed color to black
2016-03-10	S26361-F3669-E/L671	added Advanced SW Option CacheCade (with FastPath for free)
2016-03-07	S26361-F3669-E/L670	added Advanced SW Option CacheCade (with FastPath for free)
2015-09-25	S26361-F3845-E201	added 3x PSAS CP400e
2015-09-24		SATA DOM restriction added.
2015-08-26	S26361-F556*-*	added 3.5" SAS 10K HDDs
2015-07-21		RAID controller updated
2015-07-21	C2C2C4 F2042 F2	HDD SAS 12G 10K 512n added.
2015-06-01 2015-05-05	S26361-F3842-E2	added PSAS CP400i for Software Defined Storage HDD 3.5" SATA 6G 7.2K 512e 6TB added.
2015-05-05	S26361-F3904-E600 S26361-F3842-E1	removed "as soon as available"
2015-03-05	S26361-F3842-E1	added PRAID CP400i as additional RAID5 controller
2015-02-27	S26361-F5544-E118	HDD 2.5" SAS 12G 10K 512e 1.8TB
2015-02-27	S26361-F5521-*	HDD 2.5" SAS 6G 15K up to 600GB within 3.5" Carrier
2014-08-12	S26361-F3554-E512	S26361-F3554-E512: comment changed to "no BBU support" as in T50
		and generally valid for all Systems launched in 2014
2014-06-20	S26361-F3301-E120	CCC Certification for China added
2014-06-13		Configuration diagram (2 Modules) corrected
2014-05-15	S26361-F5289-E100	New 3.5" SATA SSDs added.
2014-03-04	New processors for V112	New processors only for basic unit with 12x 3.5" HDDs - as soon as available
2014-03-04	S26361-K1480-V112	New basic unit for 12x 3.5" HDDs - as soon as available
2014-01-23		First Release
-		